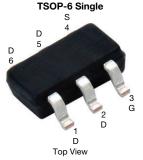
RoHS

COMPLIANT

HALOGEN FREE

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Marking code: BQ

PRODUCT SUMMARY	
V _{DS} (V)	-20
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.0240
$R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V	0.0321
$R_{DS(on)}$ max. (Ω) at V_{GS} = -1.8 V	0.0511
Q _g typ. (nC)	19.8
I _D (A) ^{a, d}	-8
Configuration	Single

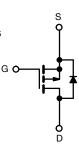
FEATURES

P-Channel 20 V (D-S) MOSFET

- TrenchFET[®] Gen III p-channel power MOSFET
- R_{DS(on)} rating at V_{GS} = -1.8 V
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Battery management in mobile devices
- · Battery switch
- · Load switch
- PA switch



P-Channel MOSFET

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3493DDV-T1-GE3

ABSOLUTE MAXIMUM RATING		1		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-20	v
Gate-source voltage		V _{GS}	± 8	v
	T _C = 25 °C		-8 ^a	
Continuous during summert (T. 150.00)	T _C = 70 °C		-8	
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	-7.5 ^{b, c}	
	T _A = 70 °C		-6 ^{b, c}	•
Pulsed drain current (t = 100 µs)		I _{DM}	-32	— A
	T _C = 25 °C		-3	
Continuous source-drain diode current	T _A = 25 °C	I _S	-1.67 ^{b, c}	
Single pulse avalanche current		I _{AS}	-10	
Single pulse avalanche energy	ergy L = 0.1 mH		5	mJ
	T _C = 25 °C		3.6	
Maximum power dissipation	T _C = 70 °C		2.3	14/
	T _A = 25 °C	P _D	2 ^{b, c}	W
	T _A = 70 °C	1 -	1.3 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stq}	-55 to +150	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^b	t ≤ 5 s	R _{thJA}	50	62.5	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	28	35	- °C/W	

Notes a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

t = 5 s. c.

d. Maximum under steady state conditions is 110 °C/W.

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Si3493DDV

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				<u> </u>		•	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	-12	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	2.5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =-250 μA	-0.4	-	-1	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$	-	-	± 100	nA	
		$V_{DS} = -20 V, V_{GS} = 0 V$	-	-	-1		
Zero gate voltage drain current	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V, T _J = 70 °C	-	-	-10	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}$	-20	-	-	Α	
	_ (0.1)	V _{GS} = -4.5 V, I _D = -7.5 A	-	0.0200	0.0240		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -2.5 V, I _D = -6.4 A	-	0.0257	0.0321	Ω	
	()	V _{GS} = -1.8 V, I _D = -2 A	-	0.0378	0.0511		
Forward transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -7.5 A	-	30	-	S	
Dynamic ^b					1		
Input capacitance	C _{iss}		-	1825	-	[
Output capacitance	C _{oss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	-	210	-	pF	
Reverse transfer capacitance	C _{rss}		-	200	-		
		$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -8 \text{ V}, \text{ I}_{D} = -7.5 \text{ A}$	-	34.8	52.2		
Total gate charge	ge Q _g <u>153 11, 133 11, 151 11</u>		-	19.8	30		
Gate-source charge	Q _{gs}	V _{DS} = -10 V, V _{GS} = -4.5 V, I _D = -7.5 A	-	2.6	-	- nC	
Gate-drain charge	Q _{gd}		_	3	-		
Gate resistance	Rg	f = 1 MHz	2.12	10.6	21.2	Ω	
Turn-on delay time	t _{d(on)}		-	25	38	-	
Rise time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{I}} = 1.67 \Omega, \text{ I}_{\text{D}} \cong -6 \text{ A},$	_	30	45		
Turn-off delay time	t _{d(off)}	$V_{GEN} = -4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	95	145		
Fall time	t _f		-	40	60		
Turn-on delay time	t _{d(on)}		-	8	16	ns	
Rise time	tr	V_{DD} = -10 V, R_L = 1.67 Ω , $I_D \cong$ -6 A,	-	20	30	1	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = -8 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	115	173		
Fall time	t _f		_	40	60		
Drain-Source Body Diode Characteristi	cs				1		
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-8		
Pulse diode forward current	I _{SM}	-	-	-	-32	A	
Body diode voltage	V _{SD}	I _S = -6 A, V _{GS} = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	21	32	ns	
Body diode reverse recovery charge	Q _{rr}		-	9	18	nC	
Reverse recovery fall time	ta	$I_F = -6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$	-	9	-		
Reverse recovery rise time	t _b		_	12	_	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

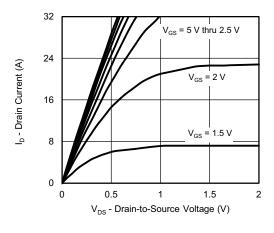
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

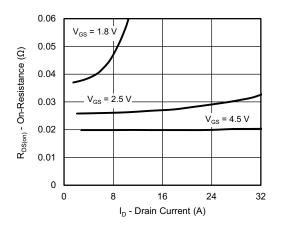


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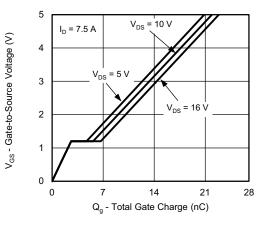
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



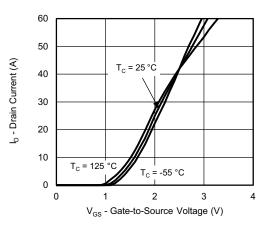
Output Characteristics



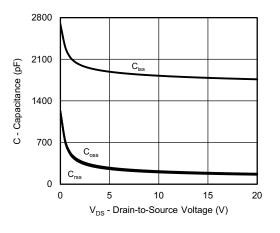
On-Resistance vs. Drain Current and Gate Voltage



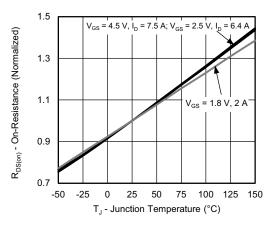
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

S16-2645-Rev. A, 26-Dec-16

3

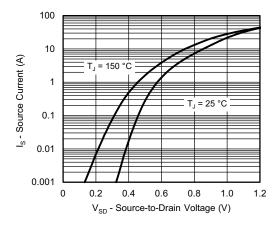
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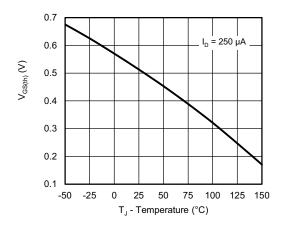


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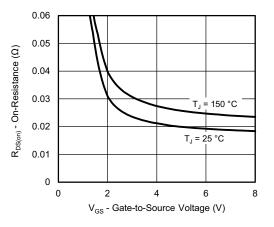
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



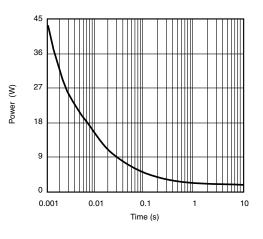
Source-Drain Diode Forward Voltage



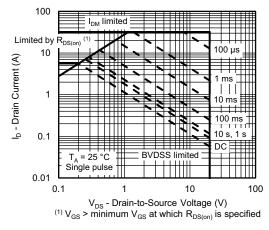
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

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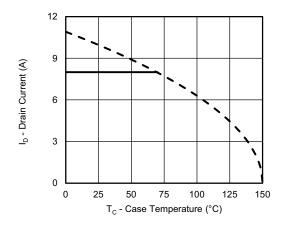
4

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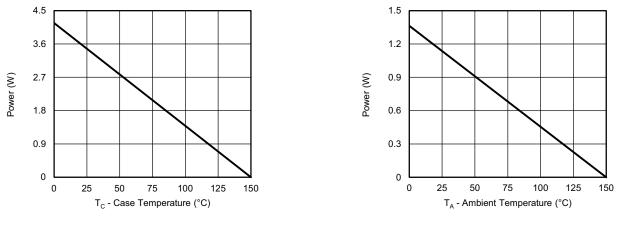


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a



Power, Junction-to-Case

Power, Junction-to-Ambient

Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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1

0.1

0.01

10-4

0.2

0.1

0.05

0.02

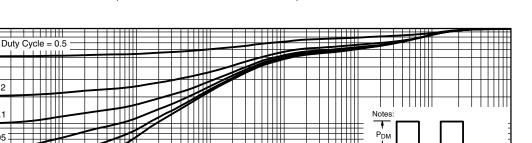
Normalized Effective Transient Thermal Impedance

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Single Pulse

10⁻²

10⁻³



1

t₁

1. Duty Cycle, D = $\frac{t_1}{t_2}$ 2. Per Unit Base = R_{thJA} = 110 °C/W

3. T_{JM} - $T_A = P_{DM}Z_{thJA}^{(t)}$

100

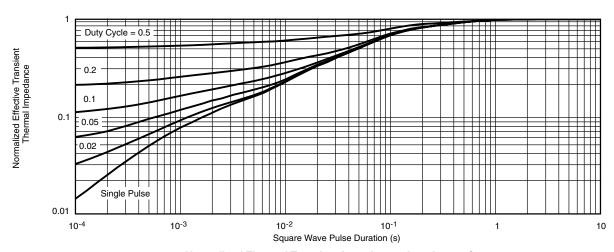
1000

4. Surface Mounted

10

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10⁻¹

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Case

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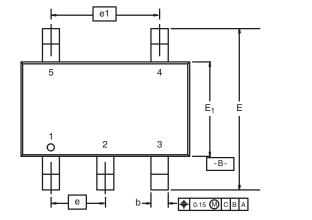
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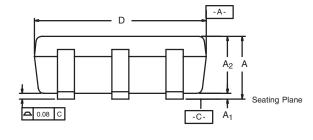
Package Information

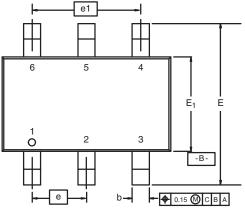
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TSOP: 5/6-LEAD JEDEC Part Number: MO-193C

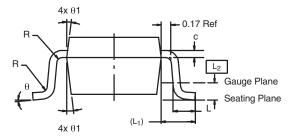








6-LEAD TSOP



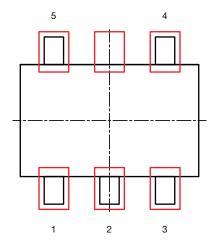
	MILLIMETERS			I	NCHES	
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.91	-	1.10	0.036	-	0.043
A ₁	0.01	-	0.10	0.0004	-	0.004
A ₂	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
С	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
Е	2.70	2.85	2.98	0.106	0.112	0.117
E ₁	1.55	1.65	1.70	0.061	0.065	0.067
е		0.95 BSC		0.0374 BSC		
e ₁	1.80	1.90	2.00	0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L ₁	0.60 Ref			0.024 Ref		
L ₂		0.25 BSC			0.010 BSC	
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
θ_1	7° Nom				7° Nom	
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540						

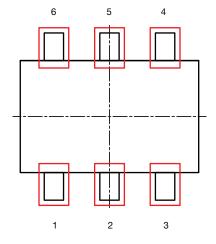
PAD Pattern



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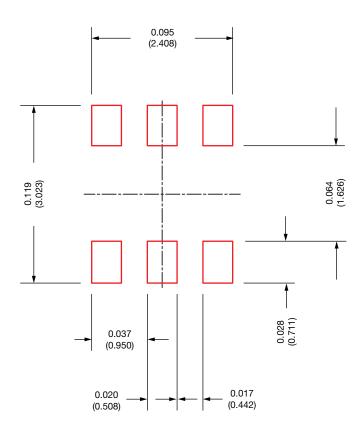
Recommended Land Pattern For TSOP-5L / TSOP-6L





TSOP-5L

TSOP-6L



Note

• All dimensions are in inches (millimeter)

ECN: S22-0593-Rev. A, 18-Jul-2022 DWG: 3010

Revision: 18-Jul-2022

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